

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: ERIC J. BERGMAN
APPLICATION No.: 10/631,376
FILED: JULY 30, 2003
FOR: METHODS OF THINNING A SILICON WAFER
USING HF AND OZONE

EXAMINER: Z. EL ARINI
ART UNIT: 1792
CONF. NO: 2135

EXAMINER INTERVIEW SUMMARY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

A telephone interview was conducted on 01/18/08. The participants were Examiner Z. El Arini and Kenneth Ohriner, attorney for Applicant. During the interview, the changes described in the 01/19/08 Examiner's Amendment were discussed and agreed to.

Dated: April 25, 2008

Respectfully submitted,

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I hereby certify that this paper (along with any referred to as being attached or enclosed) is being electronically filed with the U.S. Patent and Trademark Office on the date entered below.

April 25, 2008
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